

## Features

- 44 fixed frequencies between 4 MHz and 125 MHz
- Supply voltage of 1.5 V, 1.8 V, 2.5 V and 3.3 V ([Contact SiTime](#) for 1.2 V)
- Low power consumption of 2.5 mA typical at 1.8 V
- LVCMOS compatible output
- 1  $\mu$ A standby current
- 450 fs RMS phase jitter
- Industry-standard packages: 2.0 x 1.6, 2.5 x 2.0, 3.2 x 2.5 mm ([Contact SiTime](#) for 1.6 x 1.2 mm)
- RoHS and REACH compliant, Lead-free, Halogen-free and Antimony-free
- For AEC-Q100 oscillators and >85°C oscillators, refer to [SiT1625](#)

## Applications

- Industrial, medical and other high temp devices
- Industrial sensors, PLC, metro servos
- Outdoor networking equipment
- Medical video cam
- Asset tracking systems



Order  
samples



Buy at  
SiTimeDirect



Green  
solutions



Lifetime  
warranty

## Electrical Specifications

**Table 1. Electrical Characteristics**

All Min and Max limits are specified over temperature for all supply voltages with 15 pF output load unless otherwise stated. Typical values are specified at 25°C and at the nominal value of the highest voltage option for that parameter.

Parameters	Symbol	Min.	Typ.	Max.	Unit	Condition
Frequency Range						
Fixed Frequency Options	f	5, 10, 20, 25, 31.25, 33.333333, 50, 62.5, 78.125, 100, 125			MHz	SiT1605A
		4, 4.096, 6, 8, 8.192, 9, 12, 16, 18, 18.432, 19.2, 24, 24.576, 30.72, 32, 32.768, 36, 38.4, 48, 61.44, 64, 72, 76.8, 96, 122.88				SiT1605B
		7, 13, 21, 27, 39, 63, 91, 117				SiT1605C
Frequency Stability and Aging						
Frequency Stability	F_stab	-50	–	+50	ppm	Inclusive of Initial tolerance at 25°C, 1st year aging at 25°C, and variations over operating temperature, rated power supply voltage and load (15 pF ±10%)
		-25	–	+25		
Operating Temperature Range						
Operating Temperature Range	T_use	-40	–	+85	°C	Industrial Temperature Grade
Supply Voltage and Current Consumption						
Supply Voltage	Vdd_1.5	1.35	1.5	1.65	V	Contact SiTime for 1.2 V option (±5%)
	Vdd_1.8	1.62	1.8	1.98		
	Vdd_2.5	2.25	2.5	2.75		
	Vdd_3.3	2.97	3.3	3.63		
	Vdd_YY	1.62	–	3.63		
Current Consumption	Idd	–	2.5	3.2	mA	f = 27 MHz, no load, Vdd_1.5
		–	2.5	3.2	mA	f = 27 MHz, no load, Vdd_1.8
		–	2.6	3.4	mA	f = 27 MHz, no load, Vdd_2.5
		–	2.7	3.6	mA	f = 27 MHz, no load, Vdd_3.3
		–	2.7	3.6	mA	f = 27 MHz, no load, Vdd_YY tested at Vdd_3.3
Standby Current	I_std	–	0.15	0.6	uA	Up to 85°C, $\overline{ST}$ = 0

Table 1. Electrical Characteristics (continued)

Parameters	Symbol	Min.	Typ.	Max.	Unit	Condition
<b>LVC MOS Output Characteristics</b>						
Duty Cycle	DC	48	—	52	%	All Vdd levels
Rise/Fall Time	Tr, Tf	—	—	2.3	ns	Vdd = 1.62 V – 3.63 V, 20% - 80%, 15 pF Load, f = 27 MHz
Output High Voltage	VOH	90%	—	—	Vdd	IOH = -4 mA (Vdd = 3.0 V or 3.3 V) IOH = -3 mA (Vdd = 2.8 V and Vdd = 2.5 V) IOH = -2 mA (Vdd = 1.8 V) IOH = -1.5 mA (Vdd = 1.5 V)
Output Low Voltage	VOL	—	—	10%	Vdd	IOL = 4 mA (Vdd = 3.0 V or 3.3 V) IOL = 3 mA (Vdd = 2.8 V and Vdd = 2.5 V) IOL = 2 mA (Vdd = 1.8 V) IOL = 1.5 mA (Vdd = 1.5 V)
<b>Input Characteristics</b>						
Input High Voltage	VIH	70%	—	—	Vdd	Pin 1, OE or $\overline{ST}$
Input Low Voltage	VIL	—	—	30%	Vdd	Pin 1, OE or $\overline{ST}$
Input Pull-down Impedance	Z_in	2	—	—	MΩ	Pin 1, OE or $\overline{ST}$ or NC
<b>Startup and Resume Timing</b>						
Startup Time	T_start	—	0.5	0.7	ms	Measured from the time Vdd reaches its rated minimum value
Enable/Disable Time	T_oe	—	—	150	ns	f = 27 MHz. For other frequencies, T_oe = 100 ns + 3*cycles
Resume Time (Standby)	T_resume	—	0.5	0.7	ms	
Resume Time (Mid-Standby)		—	0.1	0.11	ms	
<b>Jitter and Phase Noise</b>						
RMS Period Jitter <sup>[1]</sup>	T_jitt	—	1	1.2	ps	f = 27 MHz, measured based on 10K cycles, Vdd = 1.8V
RMS Phase Jitter (random) <sup>[2]</sup>	T_phj_fc_2	—	0.45	0.700	ps	f = 27 MHz, 12 kHz – 20 MHz integration bandwidth, phase noise measured 12 kHz – 10 MHz and extended flat above 10 MHz
	T_phj_5	—	0.33	0.625		f = 27 MHz, 12 kHz – 5 MHz integration bandwidth, phase noise measured 12 kHz – 5 MHz
	T_phj_fc48	—	0.42	0.700		f = 48 MHz, 12 kHz – 20 MHz integration bandwidth, phase noise measured 12 kHz – to 20 MHz
Phase Noise	PN	—	-145	—	dBc/Hz	f = 27 MHz, f_offset = 100 kHz
Spurious Phase Noise	T_spn	—	-85	—	dBc	f = 27 MHz, 1.8 V, 12 kHz – 13.5 MHz integration bandwidth
Power Supply-Induced Noise Sensitivity	PSNS	—	0.8	—	ps/mV	50 mV peak-peak on supply voltage 3.3 V

## Notes:

1. Appropriate when driving digital logic for use in setup and hold time equations.
2. Appropriate when driving phase locked loops in high-speed SerDes applications.

Table 2. Absolute Maximum Limits

Operation outside the absolute maximum ratings may cause permanent damage to the part.

Performance of the IC is only guaranteed within the operational specifications, not at absolute maximum ratings.

Parameter	Min.	Max.	Unit
Storage Temperature	-65	150	°C
Supply Voltage (Vdd)	-0.5	4	V
Electrostatic Discharge (HBM)	—	2000	V
Electrostatic Discharge (CDM)	—	750	V
Soldering Temperature (follow standard Pb free soldering guidelines) <sup>[3]</sup>	—	260	°C
Junction Temperature <sup>[4]</sup>	—	150	°C

## Notes:

3. Please refer to [SiTime Manufacturing Notes](#).
4. Exceeding this temperature for extended period of time may damage the device.

**Table 3. Thermal Considerations<sup>[5]</sup>**

Package	$\theta_{JA}$ ( $^{\circ}\text{C}/\text{W}$ )	$\theta_{JB}$ ( $^{\circ}\text{C}/\text{W}$ )	$\theta_{JC}$ ( $^{\circ}\text{C}/\text{W}$ )	$\Psi_{JT}$ ( $^{\circ}\text{C}/\text{W}$ )
3225	208	76	134	15.7
2520	187	78	133	16.4
2016	190	75	167	14.9
1612	TBD	TBD	TBD	TBD

**Note:**

5.  $\theta_{JA}$ ,  $\Psi_{JT}$ ,  $\theta_{JB}$  and  $\theta_{JC}$  are provided according to JEDEC standards 51-2A, 51-7, 51-8, and 51-12.01 with a 25 $^{\circ}\text{C}$  ambient and 36.3 mW power consumption. The conduction thermal resistances  $\theta_{JB}$  and  $\theta_{JC}$  are obtained with the assumption that all heat flows from the junction to a heat sink through either the solder pads ( $\theta_{JB}$ ) or the top of the package ( $\theta_{JC}$ ). The values of  $\theta_{JA}$  and  $\Psi_{JT}$  are strongly application dependent, and we report values based on the JEDEC thermal environment of 2s2p board and still air.  $\theta_{JA}$  is the thermal resistance to ambient on a JEDEC PCB - it is a conservative estimate, since the JEDEC board does not have vias to PCB planes in the vicinity of the package.  $\Psi_{JT}$  can be used to estimate the junction temperature from accurate measurements of the temperature at the top of the package if the thermal environment is similar to the JEDEC environment.

**Table 4. Maximum Operating Junction Temperature<sup>[6]</sup>**

Max Operating Temperature (ambient)	Maximum Operating Junction Temperature
85 $^{\circ}\text{C}$	95 $^{\circ}\text{C}$

**Note:**

6. Datasheet specifications are not guaranteed if junction temperature exceeds the maximum operating junction temperature.

**Table 5. Environmental Compliance**

Parameter	Condition/Test Method
<b>Mechanical Shock</b>	MIL-STD-883F, Method 2002
<b>Mechanical Vibration</b>	MIL-STD-883F, Method 2007
<b>Temperature Cycle</b>	JESD22, Method A104
<b>Solderability</b>	MIL-STD-883F, Method 2003
<b>Moisture Sensitivity Level</b>	MSL1 @ 260 $^{\circ}\text{C}$

Device Configurations and Pin-outs

Pin Description

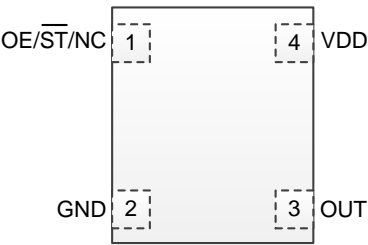


Figure 1. Pin Assignments (Top View)

Table 6. Pin Description

Pin	Symbol		Function
1	OE/ $\overline{\text{ST}}$ / NC	Output Enable (OE)	H <sup>[7]</sup> : specified frequency output L: output is high impedance. Only output driver is disabled
		Stability ( $\overline{\text{ST}}$ )	H <sup>[7]</sup> : specified frequency output L: output is low (weak pull down). Device goes to sleep mode
		No Connect (NC)	Any voltage between GND and Vdd or Open <sup>[8]</sup> . Specified frequency output. Pin 1 has no function.
2	GND	Power	Electrical ground <sup>[8]</sup>
3	OUT	Output	Oscillator output
4	VDD	Power	Power supply voltage <sup>[8]</sup>

Notes:

- 7. In OE or  $\overline{\text{ST}}$  mode, a pull-up resistor of 10 K $\Omega$  or less is recommended if pin 1 is not externally driven. If pin 1 needs to be left floating, use the NC option.
- 8. A capacitor of value 0.1  $\mu\text{F}$  between VDD and GND is required.

Test Circuit and Waveform

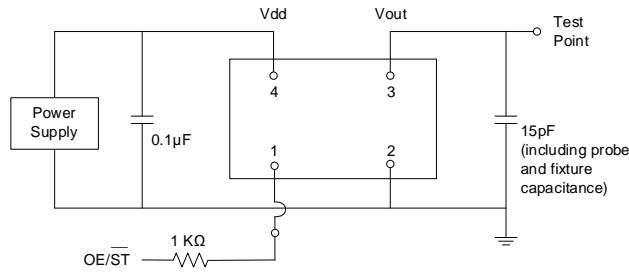


Figure 2. Test Circuit<sup>[9]</sup>

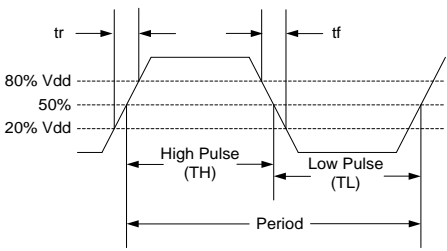


Figure 3. Waveform<sup>[9]</sup>

Note:  
9. Duty Cycle is computed as Duty Cycle = TH/Period.

Timing Diagrams

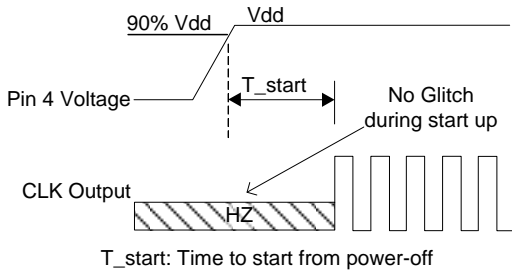


Figure 4. Startup Timing (OE/ST Mode)<sup>[10]</sup>

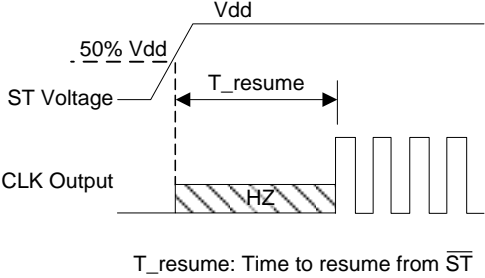


Figure 5. Standby Resume Timing (ST Mode Only)<sup>[10]</sup>

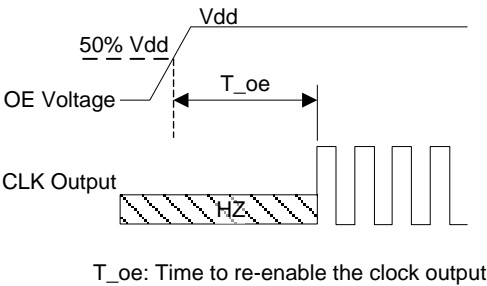


Figure 6. OE Enable Timing (OE Mode Only)

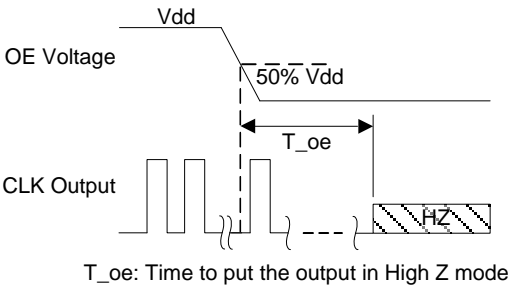


Figure 7. OE Disable Timing (OE Mode Only)

Note:  
10. SiT1605 has “no runt” pulses and “no glitch” output during startup or resume.

## Programmable Drive Strength

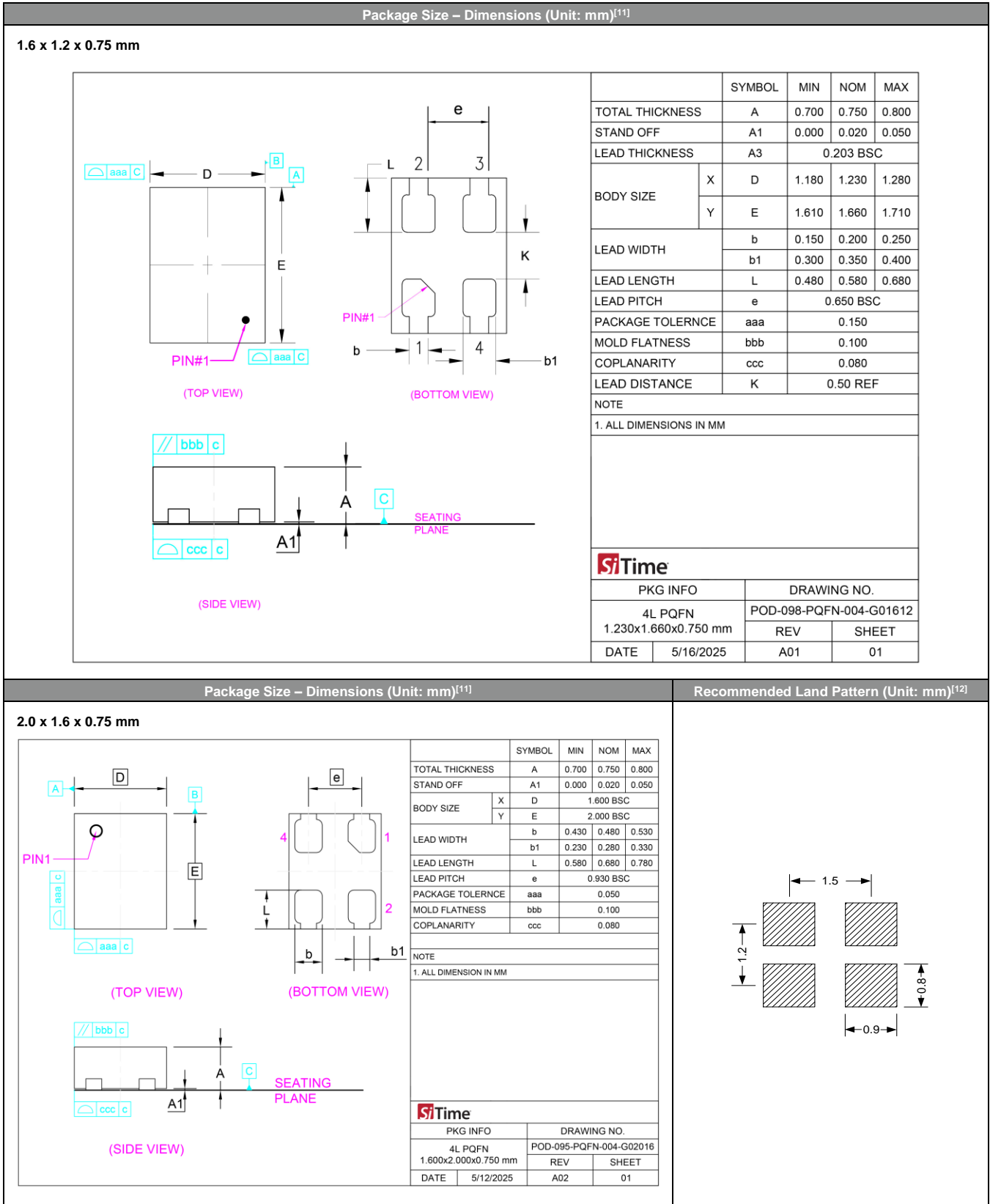
The SiT1605 includes a programmable drive strength feature to provide a simple, flexible tool to optimize the clock rise/fall time for specific applications. Benefits from the programmable drive strength feature are:

- Improves system radiated electromagnetic interference (EMI) by slowing down the clock rise/fall time.
- Improves the downstream clock receiver's (RX) jitter by decreasing (speeding up) the clock rise/fall time.
- Ability to drive large capacitive loads while maintaining full swing with sharp edge rates.

[Table 1](#) reflects the default drive strength which is optimized for fastest rise/fall times.

For more detailed information about rise/fall time control and drive strength selection, [contact SiTime](#).

Dimensions and Patterns



Dimensions and Patterns (continued)

Package Size – Dimensions (Unit: mm)<sup>[11]</sup>

Recommended Land Pattern (Unit: mm)<sup>[12]</sup>

2.5 x 2.0 x 0.75 mm

	SYMBOL	MIN	NOM	MAX			
TOTAL THICKNESS	A	0.700	0.750	0.800			
STAND OFF	A1	0.000	0.020	0.050			
BODY SIZE	X	D	2.500 BSC				
	Y	E	2.000 BSC				
LEAD WIDTH	b	0.300	0.350	0.400			
	b1	0.450	0.500	0.550			
LEAD LENGTH	L	0.650	0.750	0.850			
LEAD PITCH	e	1.250 BSC					
PACKAGE TOLERANCE	aaa	0.050					
MOLD FLATNESS	bbb	0.100					
COPLANARITY	ccc	0.080					
NOTE							
1. ALL DIMENSION IN MM							
PKG INFO		DRAWING NO.					
4L PQFN		POD-096-PQFN-004-G02520					
2.500x2.000x0.750 mm		REV	SHEET				
DATE	5/12/2025	A01	01				

3.2 x 2.5 x 0.75 mm

	SYMBOL	MIN	NOM	MAX			
TOTAL THICKNESS	A	0.700	0.750	0.800			
STAND OFF	A1	0.000	0.020	0.050			
BODY SIZE	X	D	3.200 BSC				
	Y	E	2.500 BSC				
LEAD WIDTH	b	0.800	0.900	1.000			
	L	0.700	0.800	0.900			
LEAD LENGTH	L1	0.800	0.900	1.000			
LEAD PITCH	e	2.100 BSC					
RADIUS	F	0.450 REF					
	F1	0.200 REF					
PACKAGE TOLERANCE	aaa	0.050					
MOLD FLATNESS	bbb	0.100					
COPLANARITY	ccc	0.080					
NOTE							
1. ALL DIMENSION IN MM							
PKG INFO		DRAWING NO.					
4L PQFN		POD-097-PQFN-004-G03225					
3.200x2.500x0.750 mm		REV	SHEET				
DATE	5/12/2025	A01	01				

Notes:

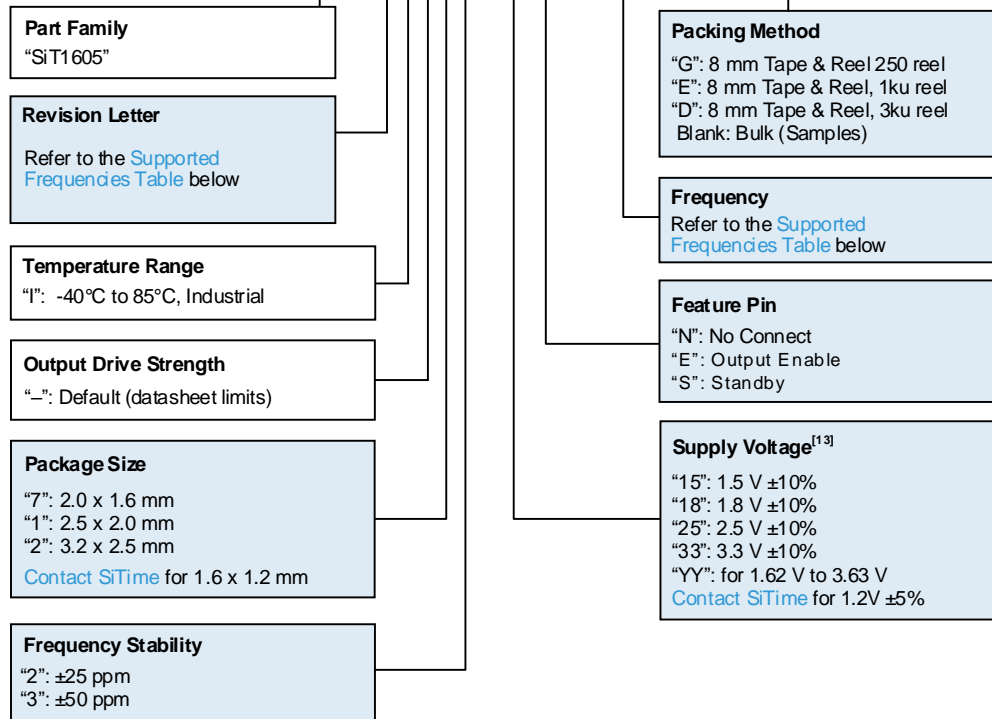
- Top marking: Y denotes manufacturing origin and XXXX denotes manufacturing lot number. The value of "Y" will depend on the assembly location of the device.
- A capacitor of value 0.1 pF or higher between VDD and GND is required.



## Ordering Information

The part number guide illustrated below is for reference only, in which boxes identify order codes having more than one option. To customize and build an exact part number, use the SiTime [Part Number Generator](#). To validate the part number, use the SiTime [Part Number Decoder](#).

### SiT1605CI-13-18N-27.000000D



**Note:**

13. The voltage portion of the SiT1605 part number consists of a two-digit number that denotes the specific supply voltage of the device. Alternatively, "YY" can be used to indicate the entire operating voltage range from 1.62 V to 3.63 V.

**Table 7. Part Number and Supported Frequencies<sup>[14]</sup>**

Frequency Range (MHz)							
SiT1605A		SiT1605B				SiT1605C	
5.000000	50.000000	4.000000	16.000000	32.000000	72.000000	7.000000	39.000000
10.000000	62.500000	4.096000	18.000000	32.768000	76.800000	13.000000	63.000000
20.000000	78.125000	6.000000	18.432000	36.000000	96.000000	21.000000	91.000000
25.000000	100.000000	8.000000	19.200000	38.400000	122.880000	27.000000	117.000000
31.250000	125.000000	8.192000	24.000000	48.000000	-	-	-
33.333333	-	9.000000	24.576000	61.440000	-	-	-
-	-	12.000000	30.720000	64.000000	-	-	-

**Notes:**

14. Any frequency the table above is supported with 6 decimal places of accuracy.

**Table 8. Ordering Codes for Supported Tape & Reel Packing Method**

Device Size (mm x mm)	8 mm T&R (3ku)	8 mm T&R (1ku)	8 mm T&R (250u)
1.6 x 1.2	D	E	G
2.0 x 1.6	D	E	G
2.5 x 2.0	D	E	G
3.2 x 2.5	D	E	G

## **Instant Samples with Time Machine II and Field Programmable Oscillator**

SiTime supports a field programmable version of the SiT1605 for fast prototyping and real time customization of features. The field programmable devices (FP devices) are available for all standard SiT1605 package sizes and can be configured to one's exact specification using the Time Machine II.

For more information regarding SiTime's field programmable solutions, see [Time Machine II](#) and [Field Programmable devices](#).

SiT1605 is typically factory-programmed per customer ordering codes for volume delivery.

## Additional Information

**Table 9. Additional Information**

Document	Description	Download Link
<b>Time Machine II</b>	Asterix programmer for engineering samples	<a href="http://www.sitime.com/support/time-machine-oscillator-programmer">http://www.sitime.com/support/time-machine-oscillator-programmer</a>
<b>Field Programmable Oscillators</b>	Devices that can be programmable in the field by Time Machine II	<a href="http://www.sitime.com/products/field-programmable-oscillators">http://www.sitime.com/products/field-programmable-oscillators</a>
<b>Manufacturing Notes</b>	Tape & Reel dimension, reflow profile and other manufacturing related info	<a href="https://www.sitime.com/sites/default/files/gated/Manufacturing-Notes-for-SiTime-Products.pdf">https://www.sitime.com/sites/default/files/gated/Manufacturing-Notes-for-SiTime-Products.pdf</a>
<b>Qualification Reports</b>	RoHS report, reliability reports, composition reports	<a href="http://www.sitime.com/support/quality-and-reliability">http://www.sitime.com/support/quality-and-reliability</a>
<b>Performance Reports</b>	Additional performance data such as phase noise, current consumption, and jitter for selected frequencies	<a href="http://www.sitime.com/support/performance-measurement-report">http://www.sitime.com/support/performance-measurement-report</a>
<b>Termination Techniques</b>	Termination design recommendations	<a href="http://www.sitime.com/support/application-notes">http://www.sitime.com/support/application-notes</a>
<b>Layout Techniques</b>	Layout recommendations	<a href="http://www.sitime.com/support/application-notes">http://www.sitime.com/support/application-notes</a>

## Revision History

**Table 10. Revision History**

Version	Release Date	Change Summary
0.1	3-Feb-2022	Initial release
0.22	15-Aug-2022	General Updates
0.23	21-Sep-2022	Additional updates on typos
0.24	30-Oct-2022	Formatting updates
0.25	9-Dec-2022	Adjusted frequency and package options Updated jitter and phase noise specifications
0.52	19-Apr-2023	Added 1612 package option
0.6	30-Jun-2023	Preliminary release, Expanded Supported Frequencies list, Updated Table 1 specs, Added Programmable Drive Strength section, Changed Phase Jitter spec, Reorganized sections
0.7	28-Jun-2024	Added 1.2V support for 2016 package. Updated Table 1 and Ordering Table for 1.2V support.
0.71	6-Sep-2024	Updated Electrical Characteristics (Current Consumption, Jitter and Phase Noise, other specs updated, reorganized sections), Ordering Information, Table 3 and Table 4
1.0	10-Jun-2025	Production Release

**SiTime Corporation**, 5451 Patrick Henry Drive, Santa Clara, CA 95054, USA | **Phone:** +1-408-328-4400 | **Fax:** +1-408-328-4439

© SiTime Corporation 2022-2025. The information contained herein is subject to change at any time without notice. SiTime assumes no responsibility or liability for any loss, damage or defect of a Product which is caused in whole or in part by (i) use of any circuitry other than circuitry embodied in a SiTime product, (ii) misuse or abuse including static discharge, neglect or accident, (iii) unauthorized modification or repairs which have been soldered or altered during assembly and are not capable of being tested by SiTime under its normal test conditions, or (iv) improper installation, storage, handling, warehousing or transportation, or (v) being subjected to unusual physical, thermal, or electrical stress.

**Disclaimer:** SiTime makes no warranty of any kind, express or implied, with regard to this material, and specifically disclaims any and all express or implied warranties, either in fact or by operation of law, statutory or otherwise, including the implied warranties of merchantability and fitness for use or a particular purpose, and any implied warranty arising from course of dealing or usage of trade, as well as any common-law duties relating to accuracy or lack of negligence, with respect to this material, any SiTime product and any product documentation. This product is not suitable or intended to be used in a life support application or component, to operate nuclear facilities, in military or aerospace applications, or in other mission critical applications where human life may be involved or at stake. All sales are made conditioned upon compliance with the critical uses policy set forth below.

### CRITICAL USE EXCLUSION POLICY

BUYER AGREES NOT TO USE SITIME'S PRODUCTS FOR ANY APPLICATION OR IN ANY COMPONENTS: USED IN LIFE SUPPORT DEVICES, TO OPERATE NUCLEAR FACILITIES, FOR MILITARY OR AEROSPACE USE, OR IN OTHER MISSION CRITICAL APPLICATIONS OR COMPONENTS WHERE HUMAN LIFE OR PROPERTY MAY BE AT STAKE.

For aerospace and defense applications, SiTime recommends using only [Endura™ ruggedized products](#).

SiTime owns all rights, title and interest to the intellectual property related to SiTime's products, including any software, firmware, copyright, patent, or trademark. The sale of SiTime products does not convey or imply any license under patent or other rights. SiTime retains the copyright and trademark rights in all documents, catalogs and plans supplied pursuant to or ancillary to the sale of products or services by SiTime. Unless otherwise agreed to in writing by SiTime, any reproduction, modification, translation, compilation, or representation of this material shall be strictly prohibited.